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ON Semiconductor®

FSUSB42 — Low-Power, Two-Port, High-Speed, USB2.0 (480Mbps) UART Switch

Features

- Low On Capacitance: 3.7 pF Typical
- Low On Resistance: 3.9 Ω Typical
- Low Pow er Consumption: 1 µA Maximum
 15 µA Maximum I_{CCT} over an Expanded Voltage Range (V_{IN}=1.8 V, V_{CC}=4.4 V)
- Wide -3 db Bandw idth: > 720 MHz
- Packaged in:
 - 10-Lead UMLP (1.4 x 1.8 mm)
 - 10-Lead MSOP
- 8 kV ESD Rating, >16 kV Pow er / GND ESD Rating
- Over-Voltage Tolerance (OVT) on all USB Ports Up to 5.25 V without External Components

Applications

- Cell phone, PDA, Digital Camera, and Notebook
- LCD Monitor, TV, and Set-Top Box

Description

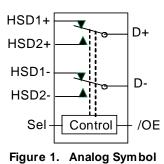
The FSUSB42 is a bi-directional, low-power, two-port, high-speed, USB2.0 switch. Configured as a double-pole, double-throw switch (DPDT) switch, it is optimized for switching between any combination of high-speed (480 Mbps) or Full-Speed (12 Mbps) sources.

The FSUSB42 is compatible with the requirements of USB2.0 and features an extremely low on capacitance (C_{ON}) of 3.7 pF. The wide bandwidth of this device (720 MHz) exceeds the bandwidth needed to pass the third harmonic, resulting in signals with minimum edge and phase distortion. Superior channel-to-channel crosstalk also minimizes interference.

The FSUSB42 contains special circuitry on the switch VO pins for applications where the V_{CC} supply is powered-off ($V_{CC}=0$ V), which allows the device to withstand an over-voltage condition. This device is designed to minimize current consumption even when the control voltage applied to the SEL pin is lower than the supply voltage (V_{CC}). This feature is especially valuable to ultra-portable applications, such as cell phones, allowing for direct interface with the general-purpose VOs of the baseband processor. Other applications include switching and connector sharing in portable cell phones, PDAs, digital cameras, printers, and notebook computers.

Ordering Information

Part Number	Top Mark	Operating Temperature Range	Package
FSUSB42UMX	HE	-40 to +85°C	10-Lead, Quad, Ultrathin Molded Leadless Package (UMLP), 1.4 x 1.8 mm
FSUSB42MUX	FSUSB42	-40 to +85°C	10-Lead, Molded Small-Outline Package (MSOP) JEDEC MO-187, 3.0 mm Wide



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Pin Assignments

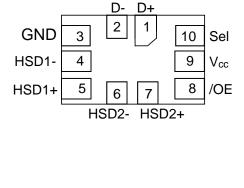
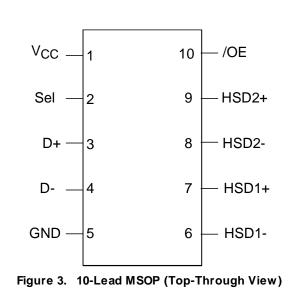


Figure 2. 10-Lead UMLP (Top-Through View)



Pin Definitions

UMLP Pin#	MSOP Pin#	Name	Description
1	3	D+	Common USB Data Bus
2	4	D-	Common USB Data Bus
3	5	GND	Ground
4	6	HSD1-	Multiplexed Source Input 1
5	7	HSD1+	Multiplexed Source Input 1
6	8	HSD2-	Multiplexed Source Input 2
7	9	HSD2+	Multiplexed Source Input 2
8	10	/OE	Sw itch Enable
9	1	Vcc	Supply Voltage
10	2	Sel	Sw itch Select

Truth Table

SEL	/OE	Function
Х	HIGH	Disconnect
LOW	LOW	D+= HSD1+, D-= HSD1-
HIGH	LOW	D+= HSD2+, D-= HSD2-

Notes: 1. LOW ≤V_{IL}.

HIGH ≥V_{IH}. 2.

X=Don't Care. 3.

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Min.	Max.	Unit	
Vcc	Supply Voltage		-0.5	5.6	V
V _{CNTRL}	DC Input Voltage (S, /OE) ⁽⁴⁾		-0.5	Vcc	V
Vsw	DC Switch I/O Voltage ⁽⁴⁾ (VCC=0V)		-0.50	5.25	V
liк	DC Input Diode Current	DC Input Diode Current			mA
ЮИТ	DC Output Current		100	mA	
T _{STG}	Storage Temperature		-65	+150	°C
MSL	Moisture Sensitivity Level (JEDEC J-STD-020		1	Level	
		All Pins	7		
	Human Body Model, JEDEC: JESD22-A114	I/O to GND	8		
		Pow er to GND	16		
ESD		D+/D-	9		kV
	IEC 61000-4-2 System on USB Connector	Air Discharge	15		1
	Pins D+ & D-	Contact	8		1
	Charged Device Model, JEDEC: JESD22-C10	2			

Note:

4. The input and output negative ratings may be exceeded if the input and output diode current ratings are observed.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. ON Semiconductor does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Min.	Max.	Unit
Vcc	Supply Voltage	2.4	4.4	V
VCNTRL	Control Input Voltage (S, /OE) ⁽⁵⁾	0	Vcc	V
V _{SW}	Switch I/O Voltage	-0.5	4.5	V
T _A	Operating Temperature	-40	+85	°C

Note:

5. The control input must be held HIGH or LOW and it must not float.

DC Electrical Characteristics

All typical value are at $T_A=25^{\circ}C$ unless otherwise specified.

Symbol	Parameter	Condition		T _A =- 4	Unit		
Symbol	T arameter	Condition	V _{cc} (V)	Min.	Тур.	Max.	Onit
Vık	Clamp Diode Voltage	l _{IN} =-18mA	3.0			-1.2	V
Maria	Input Valtage High		2.4 to 3.6	1.3			V
Vін	Input Voltage High		4.3	1.7			v
Ma			2.4 to 3.6			0.5	V
VIL	Input Voltage Low		4.3			0.7	V
lın	Control Input Leakage	V _{SW} =0 to V _{CC}	0 to 4.3	-1		1	μA
loz	Off State Leakage	$0 \le Dn$, HSD1n, HSD2n $\le 3.6 \text{ V}$	4.3	-2		2	μA
IOFF	Pow er-Off Leakage Current (All I/O Ports)	$V_{SW}=0~V$ to 4.3 V, $V_{CC}=0~V$ Figure 5	0	-2		2	μA
Devi	HS Switch On Resistance ⁽⁶⁾	V _{SW} =0.4 V, I _{ON} =-8 mA	2.4		4.5	7.5	0
R _{ON}	ns switch on Resistance	Figure 4	3.0		3.9	6.5	Ω
ΔR_{ON}	HS Delta R _{ON} ⁽⁷⁾	V _{SW} =0.4 V, I _{ON} =-8 mA	3.0		0.65		Ω
lcc	Quiescent Supply Current	V _{CNTRL} =0 or V _{CC} , l _{OUT} =0	4.3			1	μΑ
	Increase in I _{CC} Current per	V _{CNTRL} =2.6 V, V _{CC} =4.3 V	4.3			10	μA
Сст	Control Voltage and Vcc	V_{CNTRL} =1.8 V, V_{CC} =4.3 V	4.3			15	μΑ

Notes:

6. Measured by the voltage drop between HSDn and Dn pins at the indicated current through the switch. On resistance is determined by the low er of the voltage on the two (HSDn or Dn ports).

7. Guaranteed by characterization.

AC Electrical Characteristics

All typical value are for V_CC=3.3 V at T_A=25°C unless otherwise specified.

Symbol	Parameter	Condition	V _{cc} (V)	T _A =- 40°C to +85°C			11
				Min.	Тур.	Max.	Unit
ton	Turn-On Time	R _L =50 Ω, C _L =5 pF, V _{SW} =0.8 V,	2.4		24	40	
UN	S, /OE to Output	Figure 6, Figure 7	3.0 to 3.6		13	30	ns
torr	Turn-Off Time	RL=50 Ω, CL=5 pF, V _{SW} =0.8 V, $$ Figure 6, Figure 7 3	2.4		15	35	ns
toff	S, /OE to Output		3.0 to 3.6		12	25	
t _{PD}	Propagation Delay ⁸	C∟=5 pF, R∟=50 Ω, Figure 6, Figure 8	3.3		0.25		ns
t _{BBM}	Break-Before-Make	RL=50 Ω, CL=5 pF,	2.4	2.0		10	ns
rbbw	Dieak-Dei Oie-Iviake	$V_{SW1}=V_{SW2}=0.8$ V, Figure 10	3.0 to 3.6	2.0		6.5	115
Oirr	Off Isolation	RL=50 Ω , f=240 MHz, Figure 12	3.0 to 3.6		-30		dB
Xtalk	Non-Adjacent Channel Crosstalk	R_L =50 Ω , f=240 MHz, Figure 13	3.0 to 3.6		-45		dB
BW	-3db Bandwidth	$R_L=50 \Omega$, $C_L=0 pF$, Figure 11	3.0 to 3.6		720		MHz
000		RL=50 Ω , CL=5 pF, Figure 11	3.0 10 3.0		550		MHz

Note:

8. Guaranteed by characterization.

USB High-Speed-Related AC Electrical Characteristics

All typical value are for V_{CC}=3.3 V at T_A =25°C unless otherwise specified.

Symbol	Parameter	Condition	V _{cc} (V)	T _A =- 40°C to +85°C			Unit
Symbol	Falameter			Min.	Тур.	Max.	Unit
t _{SK(P)}	Skew of Opposite Transitions of the Same Output ⁽⁹⁾	$C_L=5$ pF, $R_L=50$ Ω , Figure 9			20		ps
tj	Total Jitter ⁽⁹⁾	R_L =50 Ω, C_L =5 pF, t_R = t_F =500 ps (10-90%) at 480 Mbps (PRBS= 2^{15} – 1)			200		ps

Note:

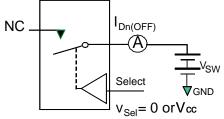
9. Guaranteed by characterization.

Capacitance

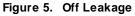
Symbol	Parameter	Condition	T _A =- 4	Unit		
Symbol	Falameter	Condition	Min.	Тур.	Max.	onn
C _{IN}	Control Pin Input Capacitance	V _{CC} =0V		1.5		
CON	D+/D- On Capacitance	V _{CC} =3.3 V, /OE=0 V, f=240 MHz, Figure 15		3.7		pF
COFF	D1n, D2n Off Capacitance	V _{CC} and /OE=3.3 V, Figure 14		2.0		

V_{ON} NC **HSD**_n Dn Vsw ON GND Select GND ∨_{Sel}=0 orVcc $R_{ON} = V_{ON} / I_{ON}$ Figure 4. On Resistance HSD_n Dn 'sw V_{CC}-. Ουτ CL GND RS Input- V_{OE} , V_{Sel} GND 10% GND V_{OH} Sel Output- V_{OUT} **∀**GND $R_L^{},\,R_S^{},\,and\,C_L^{}$ are functions of the application Vol environment (see AC Tables for specific values) C₁ includes test fixture and stray capacitance. Figure 6. AC Test Circuit Load +400mV 400mV 50% 50% Input đ٧ 10% t_{PLH} - t_{PHL} -400mV - V_{OH} Output 50% Output Vol Figure 8. Propagation Delay (t_Rt_F – 500 ps)

Test Diagrams



**Each switch port is tested separately



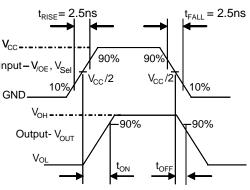


Figure 7. Turn-On / Turn-Off Waveforms

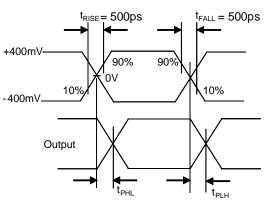
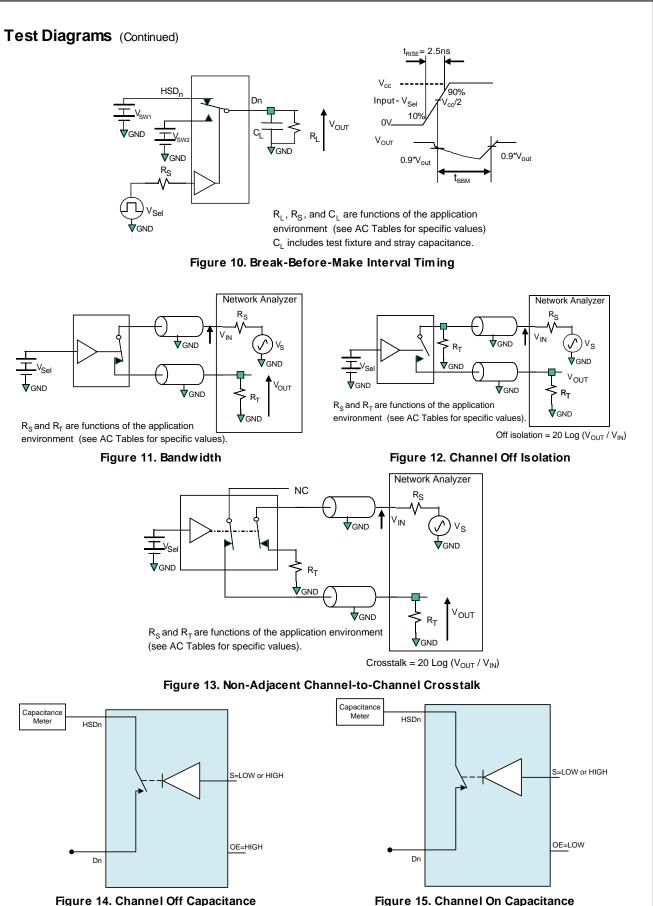
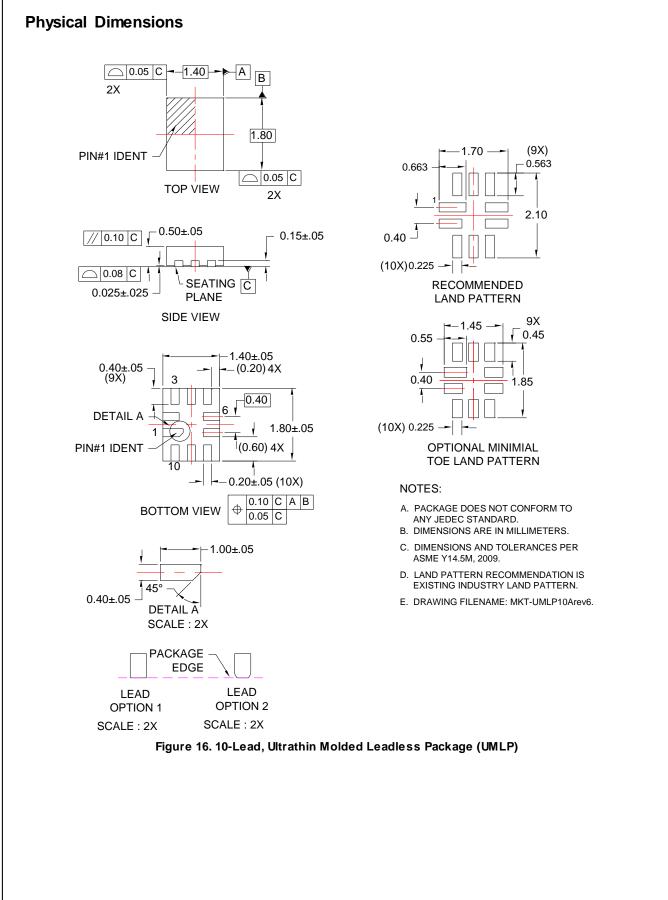
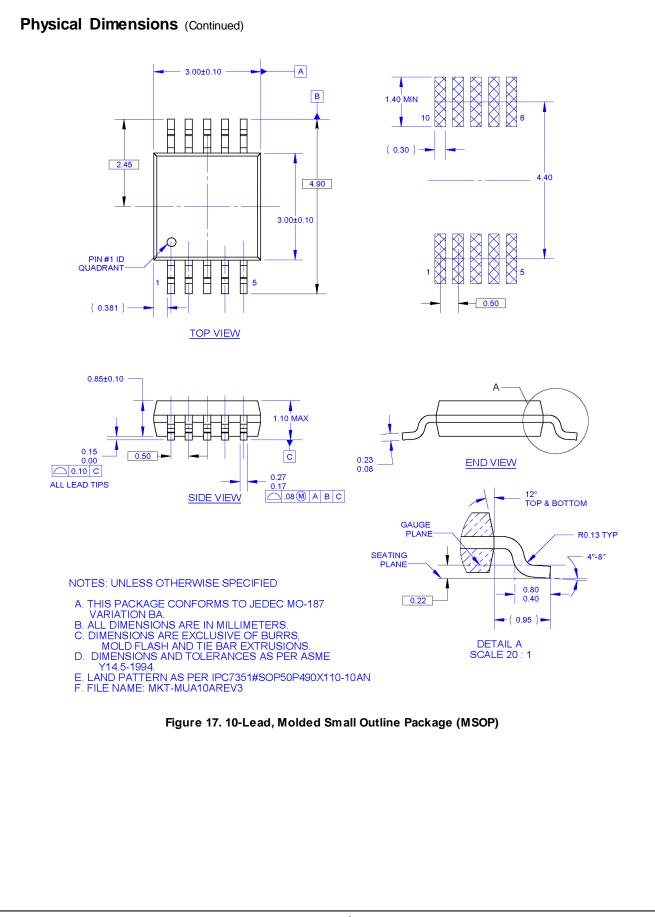


Figure 9. Intra-Pair Skew Test t_{SK(P)}



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